



5V and 3.3V Supply Monitor, Watchdog Timer, Manual Reset, with Active High & Low Resets

FEATURES

- Selectable reset voltage tolerance
 - CAT1232LP for 5V supply
 - CAT1832 for 3.3V supply
- Selectable watchdog period:
150ms, 600ms or 1.2 sec
- Two reset outputs
 - Active high, push-pull reset output
 - Active low, open-drain reset output (CAT1232LP)
 - Active low, push-pull reset output (CAT1832)
- Debounced manual push-button reset
- Compact SOIC and MSOP packages

APPLICATIONS

- Microprocessor Systems
- Portable Equipment
- Controllers
- Single Board Computers
- Instrumentations
- Telecommunications

For Ordering Information details, see page 11.

DESCRIPTION

The CAT1232LP and CAT1832 microprocessor supervisors can halt and restart a “hung-up” or “stalled” microprocessor, restart a microprocessor after a power failure, and debounce a manual/push-button microprocessor reset switch. The devices are drop in replacements for the Maxim/Dallas Semiconductor DS1232LP and DS1832 supervisors

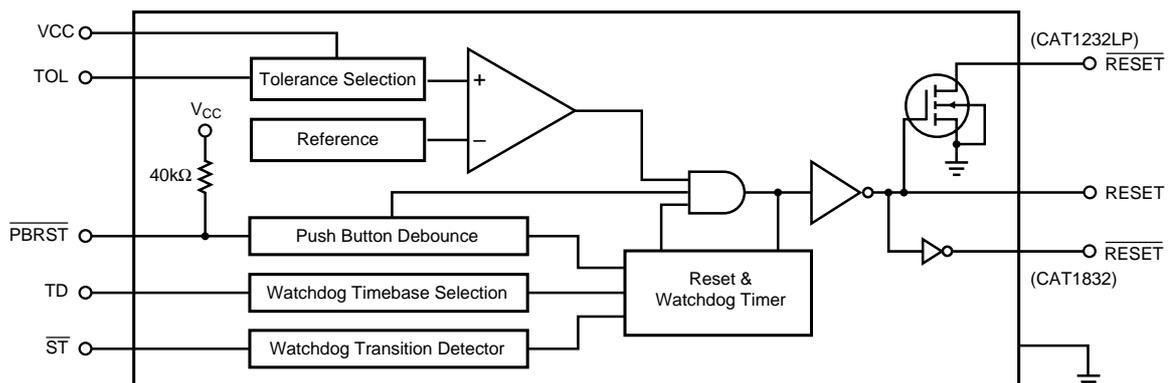
Precision reference and comparator circuits monitor the 5V or 3.3V system power supply voltage, V_{CC} . During power-up or when the power supply falls outside selectable tolerance limits, both the RESET and $\overline{\text{RESET}}$ become active. After the power supply voltage rises above the RESET threshold voltage, the reset signals remain active for a minimum of 250ms, allowing the power supply and system processor to stabilize. The trip-point tolerance input, TOL, selects the trip level tolerance to be either 5% or 10% for the CAT1232LP 5V supply and 10% or 20% for the CAT1832 3.3V supply.

Each device has a push-pull, active HIGH reset output. The CAT1232LP also has an open drain, active LOW reset output while the CAT1832 also has a push-pull, active LOW reset output.

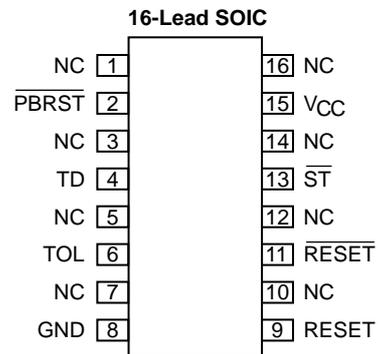
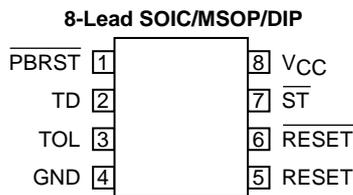
A debounced manual reset input activates the reset outputs and holds them active for a minimum period of 250ms after being released.

Also included is a watchdog timer to reset a microprocessor that has stopped due to a software or hardware failure. Three watchdog time-out periods are selectable: 150ms, 600ms and 1.2sec. If the $\overline{\text{ST}}$ input is not strobed low before the watchdog time out period expires, the reset signals become active for a minimum of 250ms.

FUNCTIONAL DIAGRAM



PIN CONFIGURATION



PIN DESCRIPTION

Pin Number 8-Lead Package	Pin Number 16-Lead Package	Name	Function
1	2	$\overline{\text{PBRST}}$	Debounced manual pushbutton reset input
2	4	TD	Watchdog typical time delay selection: a) $t_{TD} = 150\text{ms}$ for TD = GND b) $t_{TD} = 600\text{ms}$ for TD = Open c) $t_{TD} = 1200\text{ms}$ for TD = V_{CC}
3	6	TOL	CAT1232LP TOL selects 5% (TOL = GND) or 10% (TOL = V_{CC}) trip point tolerance. CAT1832 TOL selects 10% (TOL = GND) or 20% TOL = V_{CC}) trip point tolerance.
4	8	GND	Ground
5	9	RESET	Active HIGH reset output. RESET is active 1. If V_{CC} falls below the reset voltage trip point 2. If $\overline{\text{PBRST}}$ is low 3. If $\overline{\text{ST}}$ is not strobed low before the timeout period set by TD expires. 4. During power-up.
6	11	$\overline{\text{RESET}}$	Active LOW reset output. (See RESET)
7	13	$\overline{\text{ST}}$	Strobe Input
8	15	V_{CC}	Power Supply
	1, 3, 5, 7, 10, 12, 14, 16	NC	No internal connection

ABSOLUTE MAXIMUM RATINGS*

Voltage on V_{CC}	-0.5V to 7.0V	Maximum Junction Temperature	125°C
Voltage on \overline{ST} and TD	-0.5V to $V_{CC} + 0.5V$	Storage Temperature Range	-65°C to +150°C
Voltage on \overline{PBRST} , \overline{RESET} and RESET	-0.5V to $V_{CC} + 0.5V$	Lead Soldering Temperature (10 sec)	300°C
		Operating Temperature Range	-40°C to +85°C

ELECTRICAL CHARACTERISTICS

Unless otherwise stated, $1.0V \leq V_{CC} \leq 5.5V$ and over the operating temperature range of -40°C to +85°C. All voltages are referenced to ground.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{CC}	Supply Voltage		1.0		5.5	V
I_{CC1}	Supply Current	$V_{CC} = 5.5V$, CAT1232LP		35	50	μA
		$V_{CC} = 3.6V$, CAT1832		20	35	
V_{IH}	\overline{ST} and \overline{PBRST} Input High Level	(5)	2		$V_{CC} + 0.3V$	V
		(6)	$V_{CC} - 0.4V$			
V_{IL}	\overline{ST} and \overline{PBRST} Input Low Level	$V_{CC} = 5.5V$, CAT1232LP	- 0.3		0.8	V
		$V_{CC} = 3.6V$, CAT1832			0.5	
V_{CCTP}	V_{CC} Trip Point (TOL = GND)	CAT1232LP	4.50	4.62	4.74	V
V_{CCTP}	V_{CC} Trip Point (TOL = V_{CC})	CAT1232LP	4.25	4.37	4.49	V
V_{CCTP}	V_{CC} Trip Point (TOL = GND)	CAT1832	2.80	2.88	2.97	V
V_{CCTP}	V_{CC} Trip Point (TOL = V_{CC})	CAT1832	2.47	2.55	2.64	V
t_{TD}	Watchdog Time-Out Period	TD = GND	62.5	150	250	ms
t_{TD}	Watchdog Time-Out Period	TD = V_{CC}	500	1200	2000	ms
t_{TD}	Watchdog Time-Out Period	TD floating	250	600	1000	ms
V_{OH}	Output Voltage	$I = - 500\mu A^{(3)}$	$V_{CC} - 0.5V$	$V_{CC} - 0.1V$		V
I_{OH}	Output Current	Output = 2.4V ⁽²⁾		- 350		μA
I_{OL}	Output Current	Output = 0.4V,	10			mA
I_{IL}	Input Leakage	(1)	- 1.0		1.0	μA
R_{PU}	Internal Pull-Up Resistor	(1)	32	40	55	k Ω
C_{IN}	Input Capacitance				5	pF
C_{OUT}	Output Capacitance				7	pF
t_{PB}	\overline{PBRST} Manual Reset Minimum Low Time	$\overline{PBRST} = V_{IL}$	20			ms
t_{RST}	Reset Active Time		250	600	1000	ms
t_{ST}	\overline{ST} Pulse Width	(4)	20			ns
t_{RPD}	V_{CC} Fail Detect to \overline{RESET} or \overline{RESET}			5	8	μs
t_F	V_{CC} Slew Rate		20			μs
t_{PDLY}	\overline{PBRST} Stable LOW to \overline{RESET} and \overline{RESET} Active				20	ms
t_{RPU}	V_{CC} Detect to \overline{RESET} or \overline{RESET} Inactive	$t_{RISE} = 5\mu s$	250	600	1000	ms
t_R	V_{CC} Slew Rate	4.25V to 4.75V	0			ns

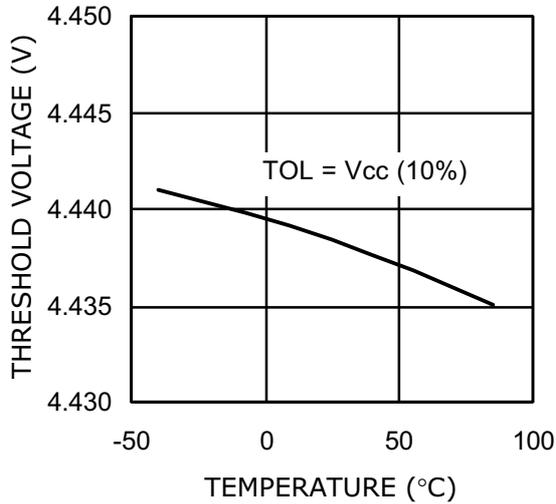
Notes:

- | | |
|---|--|
| (1) \overline{PBRST} is internally pulled HIGH to V_{CC} through a nominal 40k Ω resistor (R_{PU}). | (4) Must not exceed the minimum watchdog time-out period (t_{TD}). The watchdog circuit cannot be disabled. To avoid a reset, \overline{ST} must be strobed. |
| (2) \overline{RESET} is an open drain output on the CAT1232LP. | (5) Measured with $V_{CC} \geq 2.7V$. |
| (3) \overline{RESET} remains within 0.5V of V_{CC} on power-down until V_{CC} falls below 2V. \overline{RESET} remains within 0.5V of ground on power-down until V_{CC} falls below 2.0V. | (6) Measured with $V_{CC} < 2.7V$. |

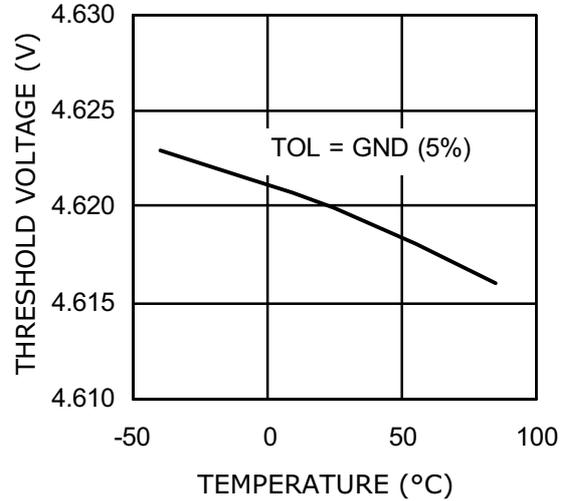
TYPICAL CHARACTERISTICS

For the CAT1232LP, $V_{CC} = 5V$ and $T_{AMB} = 25^{\circ}C$ unless otherwise stated.

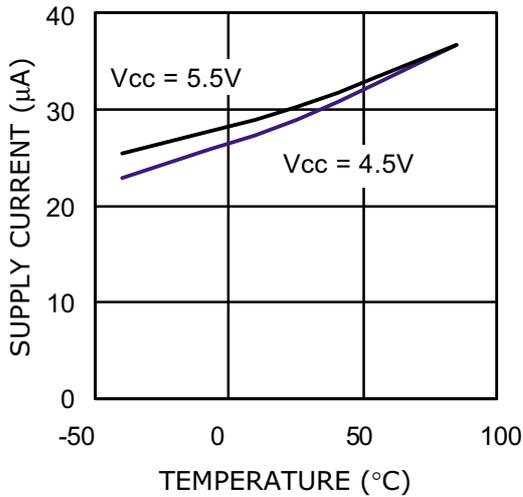
Threshold Voltage vs. Temperature (10% TOL)



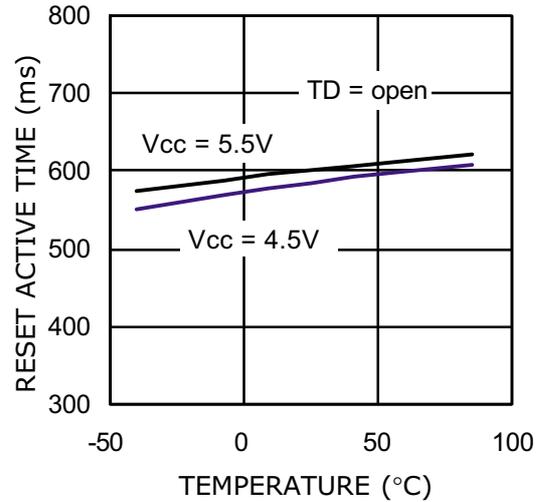
Threshold Voltage vs. Temperature (5% TOL)



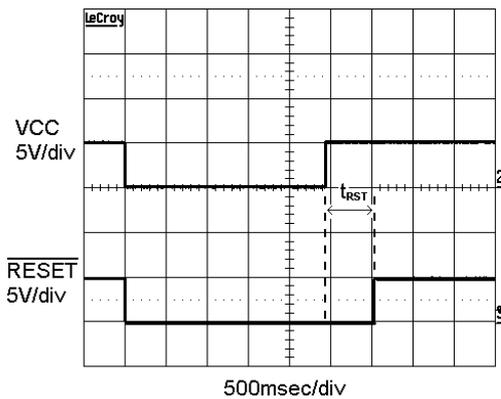
Supply Current vs. Temperature



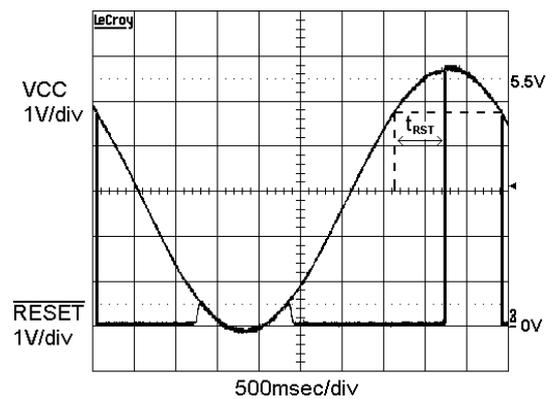
Reset Active Time vs. Temperature



Reset Active Time Waveform



Transient Response



APPLICATION INFORMATION

SUPPLY VOLTAGE MONITOR

Reset Signal Polarity and Output Stage Structure

$\overline{\text{RESET}}$ is an active LOW signal. It is developed with an open drain driver in the CAT1232LP. A pull-up resistor is required, typical values are 10k Ω to 50k Ω . The CAT1832 uses a CMOS push-pull output stage for the $\overline{\text{RESET}}$.

RESET is an active High signal developed by a CMOS push-pull output stage and is the logical opposite to $\overline{\text{RESET}}$.

Trip Point Tolerance Selection

The TOL input is used to select the V_{CC} trip point threshold. This selection is made connecting the TOL input to ground or V_{CC} . Connecting TOL to Ground makes the V_{CC} trip threshold 4.62V for the CAT1232LP and 2.88V for the CAT1832.

Connecting TOL to V_{CC} makes the V_{CC} trip threshold 4.37V for the CAT1232LP and 2.55V for the CAT1832.

After V_{CC} has risen above the trip point set by TOL, $\overline{\text{RESET}}$ and RESET remain active for a minimum time period of 250ms.

On power-down, once V_{CC} falls below the reset threshold the $\overline{\text{RESET}}$ outputs will remain active and are guaranteed valid down to a V_{CC} level of 1.0V.

Tolerance Select Voltage	Trip Point Tolerance	Trip Point Voltage (V)		
		MIN	NOMINAL	MAX
CAT1232LP TOL = V_{CC}	10 %	4.25	4.37	4.49
CAT1232LP TOL = GND	5 %	4.50	4.62	4.74
CAT1832 TOL = V_{CC}	20 %	2.47	2.55	2.64
CAT1832 TOL = GND	10 %	2.80	2.88	2.97

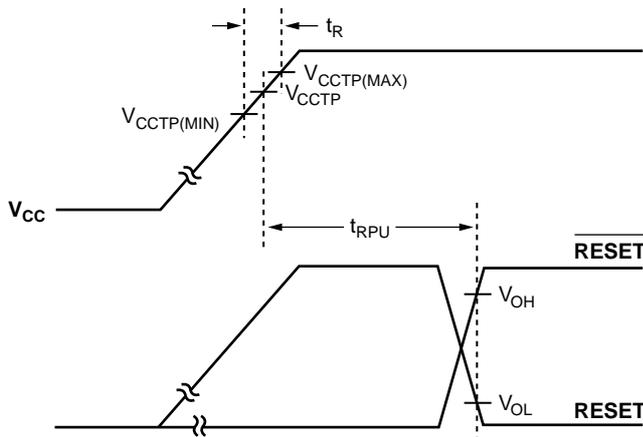


Figure 1. Timing Diagram: Power Up

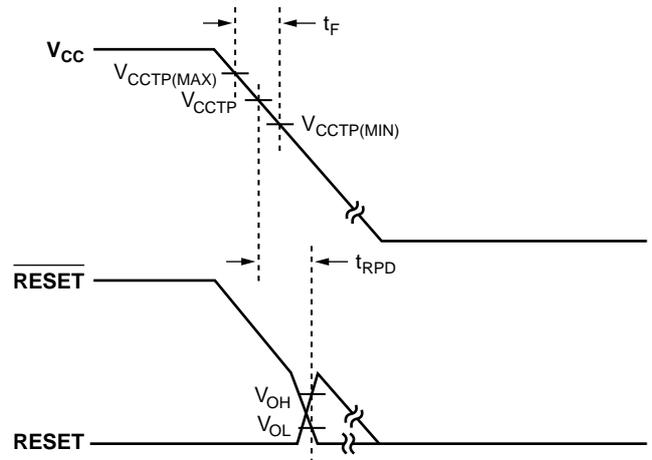


Figure 2. Timing Diagram: Power Down

Manual Reset Operation

Push-button input, $\overline{\text{PBRST}}$, allows the user to issue reset signals. The pushbutton input is debounced and is pulled high through an internal 40k Ω resistor.

When $\overline{\text{PBRST}}$ is held low for the minimum time of 20 ms, both resets become active and remain active for a minimum time period of 250ms after $\overline{\text{PBRST}}$ returns high.

No external pull-up resistor is required, since $\overline{\text{PBRST}}$ is pulled high by an internal 40k Ω resistor.

$\overline{\text{PBRST}}$ can be driven from a TTL or CMOS logic line or short-ed to ground with a mechanical switch.

WATCHDOG TIMER AND \overline{ST} INPUT

A watchdog timer stops and restarts a microprocessor that has stopped proper operation or become “hung”. The watchdog performs this function by monitoring the \overline{ST} input. After the reset outputs go inactive the \overline{ST} input must be strobed with a high-to-low signal transition prior to the minimum watchdog timeout period. However if the \overline{ST} input is not strobed with a high-to-low signal transition prior to a watchdog timeout the reset outputs will become active for T_{RST} resetting and restarting the microprocessor. Once the resets return to the inactive state the watchdog timer restarts the process.

The TD input allows the user to select from three predetermined watchdog timeout periods. Always use the minimum timeout period to determine the required frequency of \overline{ST} high-to-low transitions and the maximum to determine the time prior to the reset outputs becoming active. \overline{ST} pulse widths must be 20ns or greater.

The watchdog timer cannot be disabled. It must be strobed with a high-to-low signal transition to avoid a watchdog timeout and subsequent reset.

TD Voltage Level	Watchdog Time-out Period (ms)		
	MIN	NOMINAL	MAX
GND	62.5	150	250
Floating	250	600	1000
V _{CC}	500	1200	2000

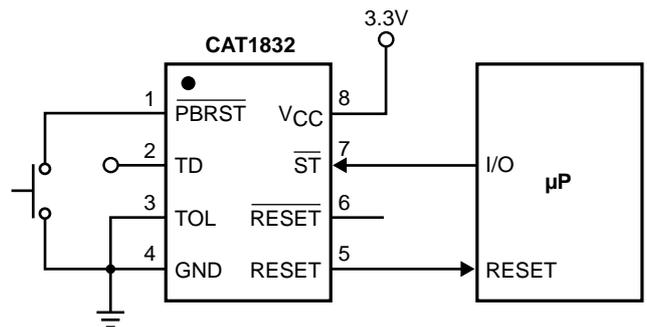


Figure 4. CAT1832 Application Circuit: Pushbutton Reset

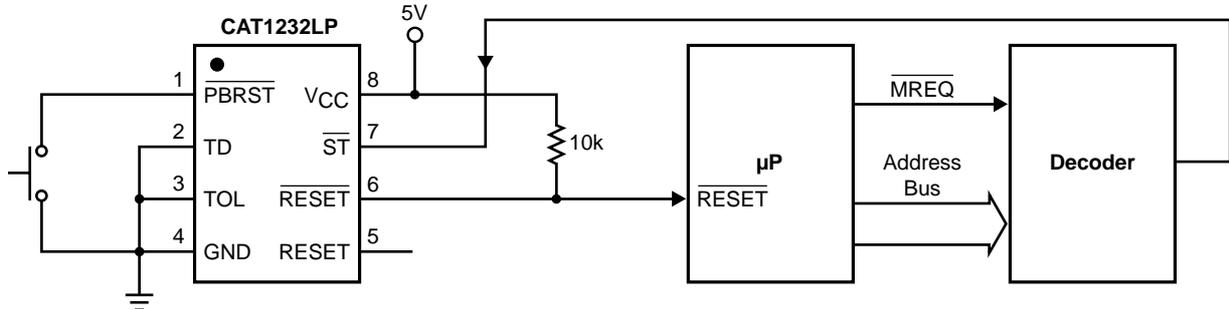


Figure 5. CAT1232LP Application Circuit: Watchdog Timer

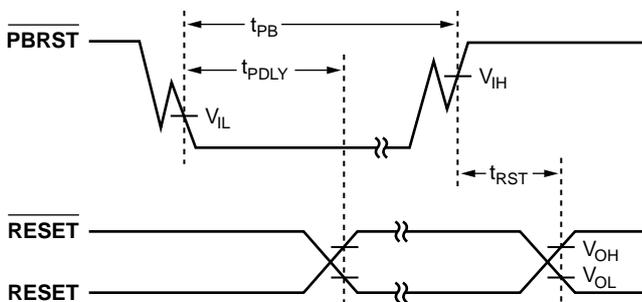


Figure 6. Timing Diagram: Pushbutton Reset

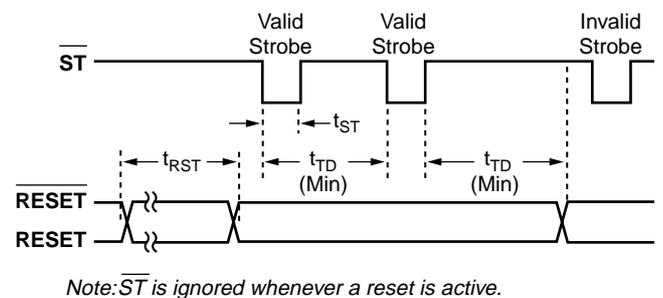
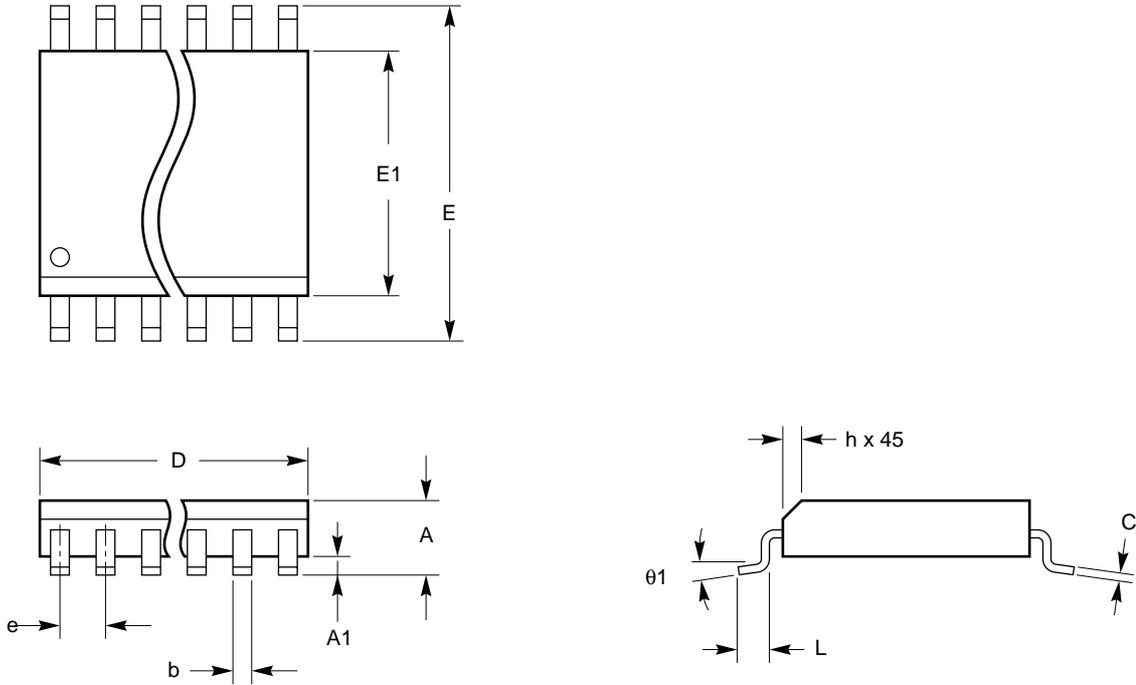


Figure 7. Timing Diagram: Strobe Input

PACKAGE DRAWING
16-LEAD WIDE BODY SOIC (300mil)



SYMBOL	MIN	NOM	MAX
A1	0.10		0.30
A	2.36	2.49	2.65
b	0.33	0.41	0.51
C	0.23	0.28	0.32
D	10.10	10.31	10.50
E	10.00	10.31	10.65
E1	7.40	7.50	7.60
e	1.27 BSC		
h	0.25		0.75
L	0.40	0.81	1.27
θ1	0°		8°

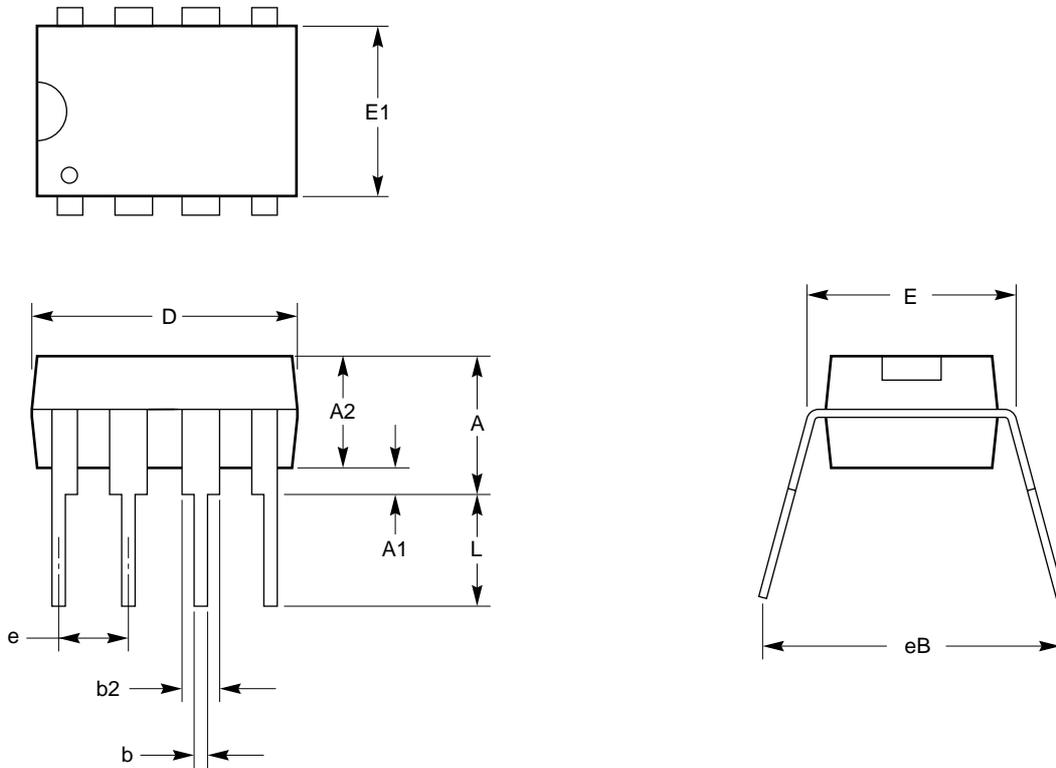
16-Lead_SOIC_(300mil).eps

For current Tape and Reel information, download the PDF file from:
<http://www.catsemi.com/documents/tapeandreel.pdf>

Notes:

1. All dimensions are in millimeters.
2. Complies with JEDEC specification MS-013.

PACKAGE DRAWING
8-LEAD DIP (300mil)



SYMBOL	MIN	NOM	MAX
A			4.57
A1	0.38		
A2	3.05		3.81
b	0.36	0.46	0.56
b2	1.14		1.52
D	9.02		10.16
E	7.62	7.87	8.26
E1	6.17	6.35	7.49
e	2.54 BSC		
eB	7.87		9.65
L	2.79		3.81

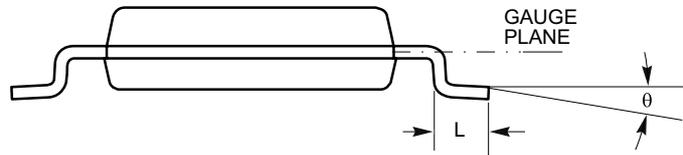
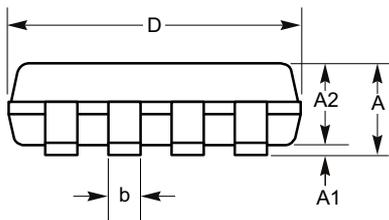
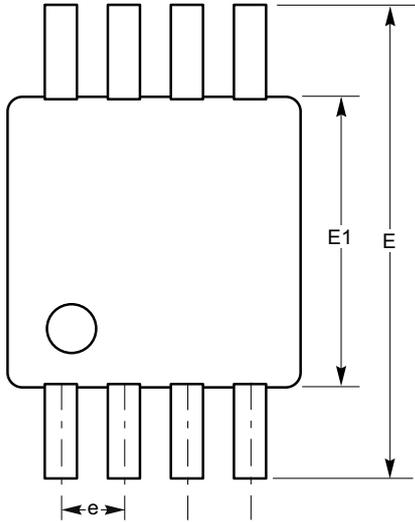
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Notes:

1. All dimensions are in millimeters.
2. Complies with JEDEC Standard MS001.
3. Dimensioning and tolerancing per ANSI Y14.5M-1982

PACKAGE DRAWING
8-LEAD MSOP



SYMBOL	MIN	NOM	MAX
A			1.10
A1	0.00		0.15
A2	0.75		0.95
b	0.22		0.38
D	2.90	3.00	3.10
E	4.80	4.90	5.00
E1	2.90	3.00	3.10
e	0.65 BSC		
L	0.40		0.8
θ	0°		8°

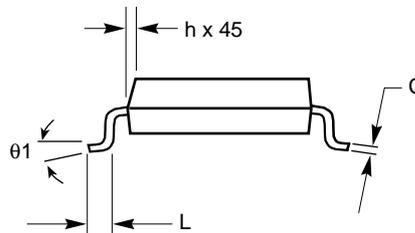
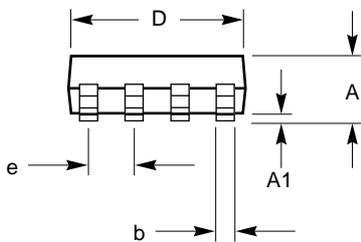
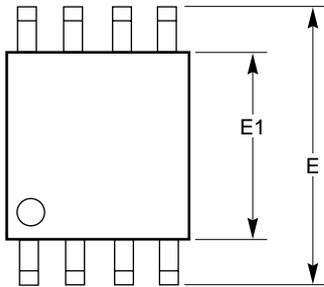
8-lead_MSOP3.eps

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Notes:

1. All dimensions are in millimeters. Angles in degrees.
2. Complies with JEDEC Specification MO-187.
3. Stand off height/coplanarity are considered as special characteristics.

PACKAGE MECHANICAL
8-LEAD Narrow Body SOIC (150mil)



SYMBOL	MIN	NOM	MAX
A1	0.10		0.25
A	1.35		1.75
b	0.33		0.51
C	0.19		0.25
D	4.80		5.00
E	5.80		6.20
E1	3.80		4.00
e	1.27 BSC		
h	0.25		0.50
L	0.40		1.27
theta 1	0°		8°

24C16_8-LEAD_SOIC.eps

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Notes:

1. All dimensions are in millimeters. Angles in degrees.
2. Complies with JEDEC Specification MS-012.

REVISION HISTORY

Date	Revision	Comments
06/13/2005	00	Initial Issue
07/26/2005	0A	Update Electrical Characteristics Add Typical Characteristics
03/27/2006	0B	Update Document Title Update Ordering Information
08/21/2006	0C	Add Ordering Information detail to page 1 Update Sample of Ordering Information

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